

#### **Features**

- 0603 0.8mm SMD LED
- High Brightness
- AlInGaP / InGaN Technology
- Small package
- High reliability

### **Applications**

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

#### **Description**

The IN-S63CT series is a popular low profile 0603 package with versatile design capabilities. It is a PCB type molding style LED which can be used in various applications.

#### **Recommended Solder Pattern**

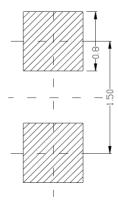
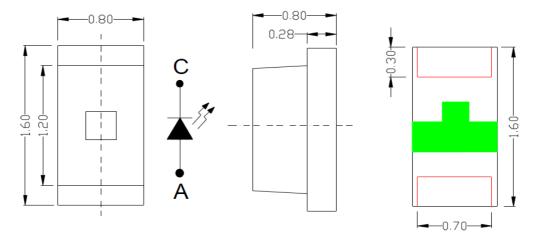


Figure 1. IN-S63CT Series Solder Pattern

### Package Dimensions in mm



#### Notes.

- All dimensions are in millimeters.
- 2. Tolerance is ± 0.1 mm unless otherwise noted

Figure 2. IN-S63CT Package Dimensions



### Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P <sub>d</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> * (mA)	V <sub>R</sub> (V)	T <sub>OP</sub> (°C)	T <sub>ST</sub> (°C)
IN-S63CTYG	Yellow Green	75	25	70			
IN-S63CTY	Yellow	75	25	70			
IN-S63CTA	Amber	75	25	70			-40°C~+90°C
IN-S63CTR	Red	75	25	70	5	-30°C~+85°C	
IN-S63CT5B	Blue	75	25	100			
IN-S63CTG	Green	75	25	100			
IN-S63CT5UW	White	75	25	100			

#### **Notes**

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

#### **ESD Precaution**

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).



# **Electrical Characteristics** $T_A = 25\%$ (Note 1)

Product	Emission	I <sub>F</sub> (mA)	V <sub>F</sub> (V)		λ(nm)		Viewing Angel	I <sup>*</sup> <sub>V</sub> (mcd)
	Color		typ.	$\lambda_{D}$	$\lambda_{P}$	Δλ	2θ1/2	typ.
IN-S63CTYG	Yellow Green	20	2.2	572	576	15	120	45
IN-S63CTY	Yellow	20	2.2	591	595	15	120	115
IN-S63CTA	Amber	20	2.2	606	610	17	120	115
IN-S63CTR	Red	20	2.2	622	630	20	120	140
IN-S63CT5B	Blue	5	2.8	468	476	30	120	45
IN-S63CTG	Green	20	3.2	522	530	35	120	720
IN-S63CT5UW	White	5	2.8	X=0.32 Y=0.33	-	-	120	285

#### **Notes**

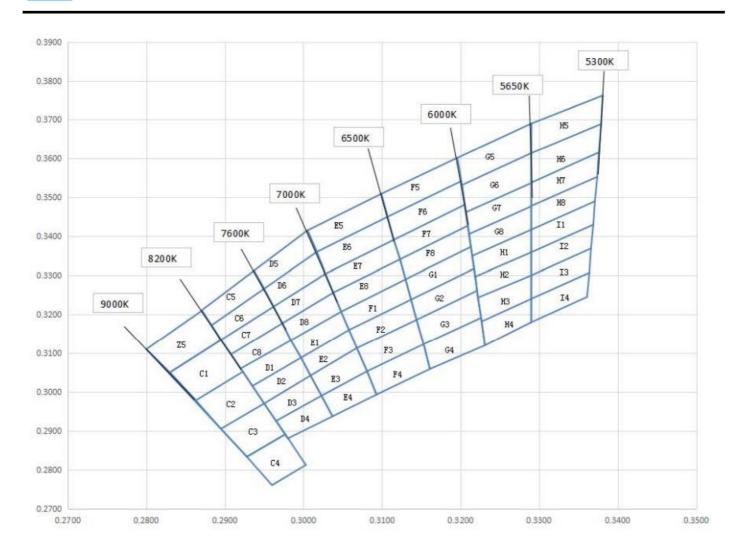
<sup>1.</sup> Performance guaranteed only under conditions listed in above tables.



# **Chromaticity Bin (for White only)**

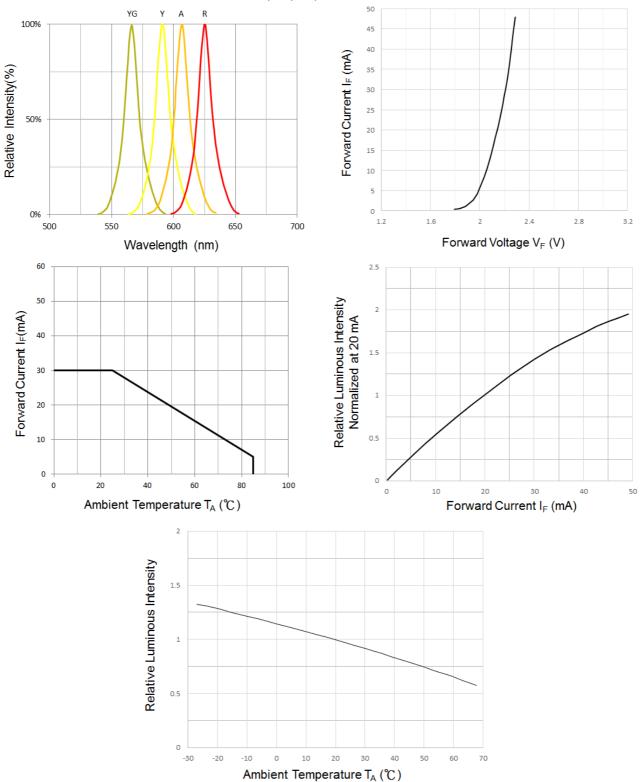
Bin	CIEV	CIEV	Bin	CIEV	CIEV	Bin	CIEV	CIEV	Bin	CIEV	CIE V
Code	CIE-X	CIE-Y	Code	CIE-X	CIE-Y	Code	CIE-X	CIE-Y	Code	CIE-X	CIE-Y
	0, 28	0.311	-	0, 2950	0, 2970		0, 3017	0, 3360		0, 3130	0,3290
<b>Z</b> 5	0.2871	0.321	D3	0. 2965	0. 2925	E6	0. 3028	0. 3304	G1	0. 3137	0. 3238
	0, 2895	0, 3134	1	0.3023	0. 2990		0. 3115	0. 3391		0. 3217	0.3317
	0.2830	0.3050		0. 2965	0. 2925		0. 3028	0. 3304		0. 3213	0.3238
	0.2863	0.2978	١	0. 2980	0. 2880		0. 3038	0. 3256		0. 3144	0.3186
C1	0, 2923	0, 3052	D4	0. 3037	0. 2937	E7	0, 3123	0. 3341	G2	0. 3221	0. 3261
	0.2895	0.3134	1	0.3023	0. 2990		0.3115	0. 3391		0.3217	0.3317
	0.2863	0.2978		0. 2937	0.3312		0. 3038	0. 3256		0.3144	0.3186
C2	0.2895	0.2905	D5	0. 2950	0. 3266	E8	0. 3048	0. 3207	G3	0.3153	0.3123
(2	0.2950	0.2970	ра	0.3017	0. 3360	1.8	0.3130	0. 3290	63	0. 3226	0.3191
	0, 2923	0, 3052	1	0.3005	0.3415		0.3123	0.3341		0.3221	0.3261
	0.2895	0.2905		0. 2950	0. 3266		0.3048	0. 3207		0.3153	0.3123
C3	0.2928	0.2833	D6	0. 2962	0. 3220	F1	0. 3058	0.3160	G4	0.3161	0.3059
	0.2977	0.2891		0. 3028	0. 3304		0. 3137	0. 3238	01	0. 3231	0.3120
	0, 2950	0, 2970		0, 3017	0, 3360		0, 3130	0, 3290		0, 3226	0.3191
	0.2928	0.2833	]	0. 2962	0. 3220		0. 3058	0.3160		0. 3202	0.3532
C4	0.2977	0.2891	D7	0. 2973	0.3177	F2	0. 3068	0.3113	G5	0. 3290	0.3614
	0.3003	0.2812		0.3038	0.3256		0.3144	0.3186		0. 3290	0.3690
	0.2960	0.2760		0.3028	0. 3304		0.3137	0. 3238		0.3196	0.3602
	0.2883	0.3172		0.2973	0.3177		0.3068	0.3113		0.3202	0.3532
C5	0.2870	0.3210	D8	0. 2984	0. 3133	F3	0.3081	0.3053	G6	0. 3207	0.3462
"	0.2937	0.3312		0.3048	0. 3207		0.3153	0.3123		0. 3290	0.3537
	0.2950	0.3266		0.3038	0. 3256		0.3144	0.3186		0. 3290	0.3614
	0.2883	0.3172		0. 2973	0.3177		0.3081	0.3053		0. 3207	0.3462
C6	0.2950	0.3266	E1	0. 2984	0. 3133	F4	0.3093	0. 2993	G7	0.3211	0.3406
	0.2962	0.3220		0.3048	0. 3207		0.3161	0.3059		0. 3290	0.3477
	0, 2895	0, 3134		0, 3038	0, 3256		0, 3153	0, 3123		0, 3290	0.3537
	0.2895	0.3134	ļ	0. 2973	0. 3177		0. 3099	0. 3509		0. 3211	0.3406
C7	0.2908	0.3097	E2	0. 2984	0. 3133	F5	0. 3107	0.3450	G8	0. 3215	0.3350
	0.2973	0.3177		0.3048	0. 3207		0. 3201	0.3542		0. 3290	0.3417
	0.2962	0.3220		0.3038	0. 3256		0.3196	0.3602		0. 3290	0.3477
	0.2908	0.3097		0. 2973	0. 3177		0. 3107	0.3450		0. 3215	0.3350
C8	0.2920	0.3060	E3	0. 2984	0. 3133	F6	0. 3115	0. 3391	H1	0. 3219	0.3297
	0.2984	0.3133		0.3048	0. 3207		0. 3205	0.3481		0. 3290	0.3359
	0.2973	0.3177		0. 3038	0. 3256		0. 3201	0. 3542		0. 3290	0.3417
	0.2920	0.3060	ļ	0. 2973	0. 3177		0. 3115	0. 3391		0. 3219	0.3297
D1	0.2935	0.3015	E4	0. 2984	0. 3133	F7	0. 3123	0. 3341	H2	0. 3222	0.3243
"	0.2997	0.3088		0.3048	0. 3207		0. 3209	0.3427		0. 3290	0.3300
	0.2984	0.3133		0.3038	0. 3256		0. 3205	0.3481		0.3290	0.3359
	0.2935	0.3015		0. 2973	0.3177		0.3123	0.3341		0. 3222	0.3243
D2	0.2950	0.2970	E5	0. 2984	0. 3133	F8	0.3130	0. 3290	НЗ	0. 3227	0.3182
-0.2	0.3009	0.3042	2.0	0.3048	0. 3207	10	0. 3213	0. 3373	110	0. 3290	0.3240
	0.2997	0.3088		0.3038	0. 3256		0. 3209	0.3427		0. 3290	0.3300
	0.3227	0.3182		0. 3290	0.3690		0. 3290	0.3614		0. 3290	0.3538
H4	0.3231	0.3120	H5	0. 3290	0.3614	не	0. 3290	0. 3538	H7	0.3290	0.3478
H4	0.3290	0.3180	H5	0. 3379	0.3689	Н6	0. 3376	0.3616	Н7	0.3374	0.3553
1 k											





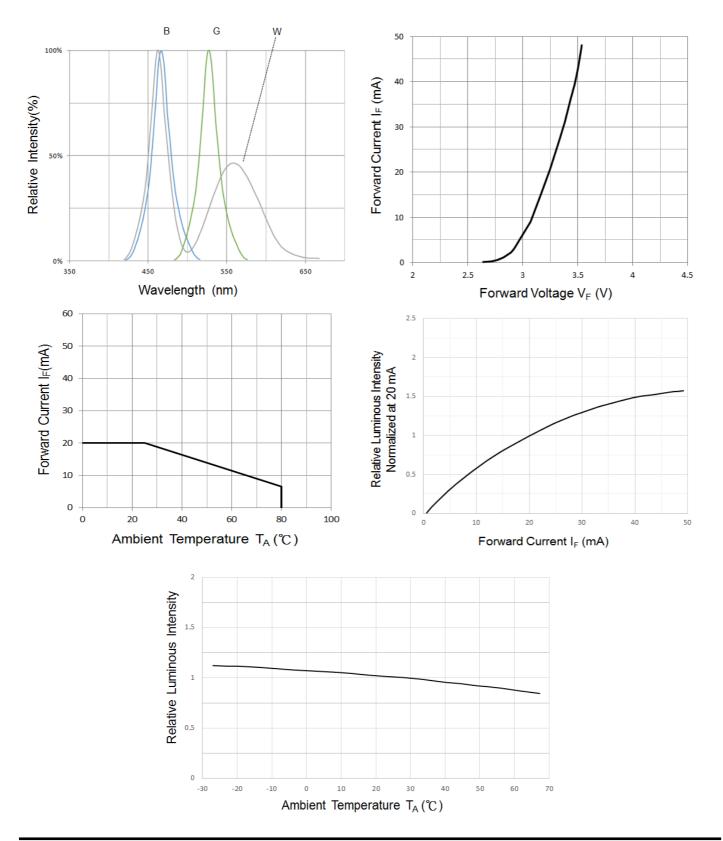


# Typical Characteristic Curves - YG, Y, A, R



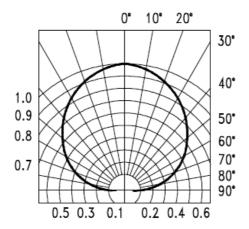


### Typical Characteristic Curves - B, G, W





### **Typical Characteristic Curves – Radiation Pattern**

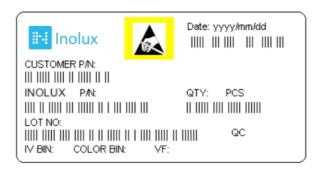


# **Ordering Information**

Product	Emission Color	Technology	Test Current I <sub>F</sub> (mA)	Luminous Intensity I <sub>V</sub> (mcd) (Typ.)	Forward Voltage V <sub>F</sub> (V) (Typ.)	Orderable Part Number
IN-S63CTYG	Yellow Green	AllnGaP	20	45	2.2	IN-S63CTYG
IN-S63CTY	Yellow	AllnGaP	20	115	2.2	IN-S63CTY
IN-S63CTA	Amber	AllnGaP	20	115	2.2	IN-S63CTA
IN-S63CTR	Red	AllnGaP	20	140	2.2	IN-S63CTR
IN-S63CT5B	Blue	InGaN	5	45	2.8	IN-S63CT5B
IN-S63CTG	Green	InGaN	20	720	3.2	IN-S63CTG
IN-S63CT5UW	White	InGaN	5	285	2.8	IN-S63CT5UW



# **Label Specifications**



#### Inolux P/N:

I	N	-	S	6	3	С	Т			Х	-	Х	Χ	Χ	Χ
			Material	Pacl	kage	Variation	Orientation	Current	Lens	Color			ıstor tam <sub>l</sub>		
	olux MD		S = PCB Type	63C :	= 1.6 x (	0.8 x 0.8mm	T = Top Mount	(Blank) = 20mA 5=5mA	(Blank) = Clear U = Diffused	R=630nm A=610nm Y=595nm YG=576nm G=530nm B=476nm W=White					

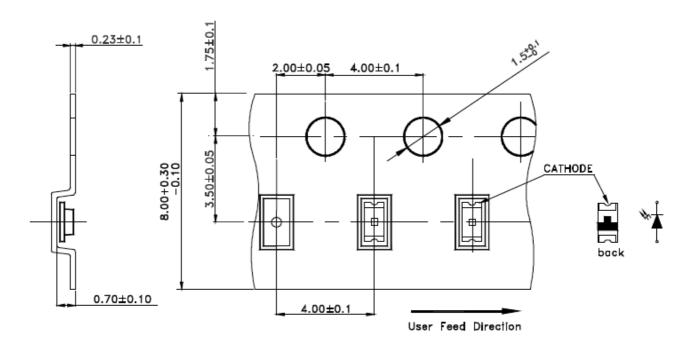
#### Lot No.:

Z	2	0	1	7	01	24	001
Internal		Year (2017	2018 )	Month	Date	Serial	
Tracker		rear (2017)	, 2010,,		141011611	Date	Scriai

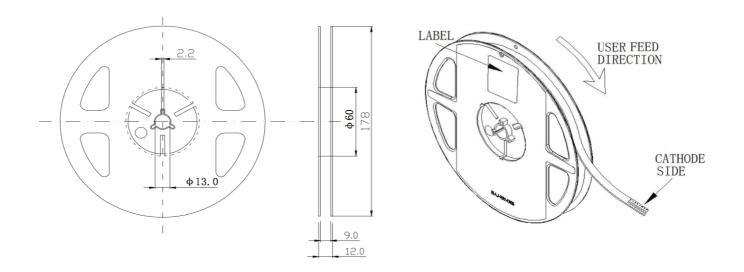


### Packaging Information: 4000pcs Per Reel

# **Tape Dimension**

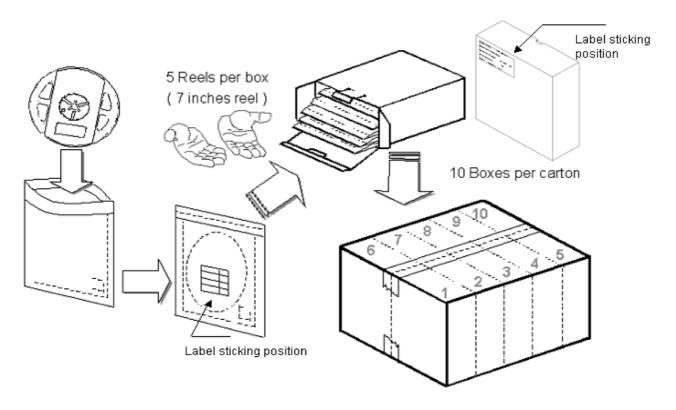


### **Reel Dimension**





# **Packing Dimension**



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified
Othorou			

#### Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv,  $\lambda_D$  and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

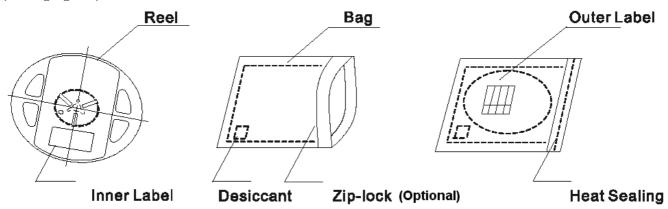


#### **Dry Pack**

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

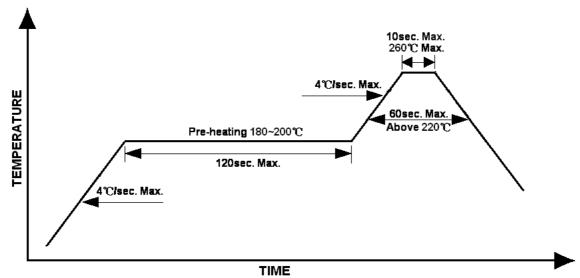
The packaging sequence is as follows:



### **Reflow Soldering**

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

#### Lead-free Solder Profile





#### **Precautions**

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

#### Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

#### Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min</li>

#### **Cautions of Pick and Place**

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.





Reliability

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Item	Frequency/ lots/ samples/	Standards	Conditions
	failures	Reference	
	For all reliability	J-STD-020	1.) Baking at 85°C for 24hrs
Precondition	monitoring tests according		2.) Moisture storage at 85°C/ 60% R.H. for
	to JEDEC Level 2		168hrs
	1Q/ 1/ 22/ 0	JESD22-B102-B	Accelerated aging 155°C/ 24hrs
Solderability		And CNS-5068	Tinning speed: 2.5+0.5cm/s
			Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
		CNS-5067	Dipping soldering terminal only
Resistance to			Soldering bath temperature
soldering heat			A: 260+/-5°C; 10+/-1s
3			B: 350+/-10°C; 3+/-0.5s
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs
Operating life test			85°C/ 60%R.H. for 168hrs
			2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C
high temperature		0202711012	Humidity: 85% R.H., IF=5mA
bias			Duration: 1000hrs
	1Q/ 1/ 20	IN specs.	Tamb: 55°C
High temperature	1 47 17 20	opodo:	IF=20mA
bias			Duration: 1000hrs
	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty
Pulse life test	1 47 17 107 0		cycle=0.125 (tp=125 $\mu$ s,T=1sec)
I disc inc test			Duration 500hrs)
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C
	10/ 1/ 70/ 0	IEC 68-2-14, Nb	15min
Temperature		1LC 00-2-14, ND	Thermal steady within 5 min
cycle			300 cycles
Lliada la considita d	1Q/ 1/ 40/ 0	CNS-6117	2 chamber/ Air-to-air type 60+3°C
High humidity	10/ 1/ 40/ 0	CN3-0117	90+5/-10% R.H. for 500hrs
storage test	10/1/10/0	CNC FF4	
High temperature	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
storage test	10/1/10/0	010 0440	40 500 ( 500)
Low temperature	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs
storage test			



# IN-S63CT series Top View SMD LED 0603 PCB Type

**Revision History** 

Changes since last revision	Page	Version No.	Revision Date
Initial Release		V1.0	05-12-2017
Updated (new standard)	3,8	V1.1	08-26-2021

#### **DISCLAIMER**

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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.